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#### Details

Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	48 MIPS
Connectivity	EBI/EMI, I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	40
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.25V
Data Converters	A/D 32x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/silicon-labs/c8051f388-b-gq">https://www.e-xfl.com/product-detail/silicon-labs/c8051f388-b-gq</a>

**Table 3.1. Pin Definitions for the C8051F388/9/A/B (Continued)**

Name	Pin Numbers		Type	Description
	48-pin	32-pin		
P3.2	28	—	D I/O or A In	Port 3.2.
P3.3	27	—	D I/O or A In	Port 3.3.
P3.4	26	—	D I/O or A In	Port 3.4.
P3.5	25	—	D I/O or A In	Port 3.5.
P3.6	24	—	D I/O or A In	Port 3.6.
P3.7	23	—	D I/O or A In	Port 3.7.
P4.0	22	—	D I/O or A In	Port 4.0. See Section 20 for a complete description of Port 4.
P4.1	21	—	D I/O or A In	Port 4.1.
P4.2	20	—	D I/O or A In	Port 4.2.
P4.3	19	—	D I/O or A In	Port 4.3.
P4.4	18	—	D I/O or A In	Port 4.4.
P4.5	17	—	D I/O or A In	Port 4.5.
P4.6	16	—	D I/O or A In	Port 4.6.
P4.7	15	—	D I/O or A In	Port 4.7.

# C8051F388/9/A/B

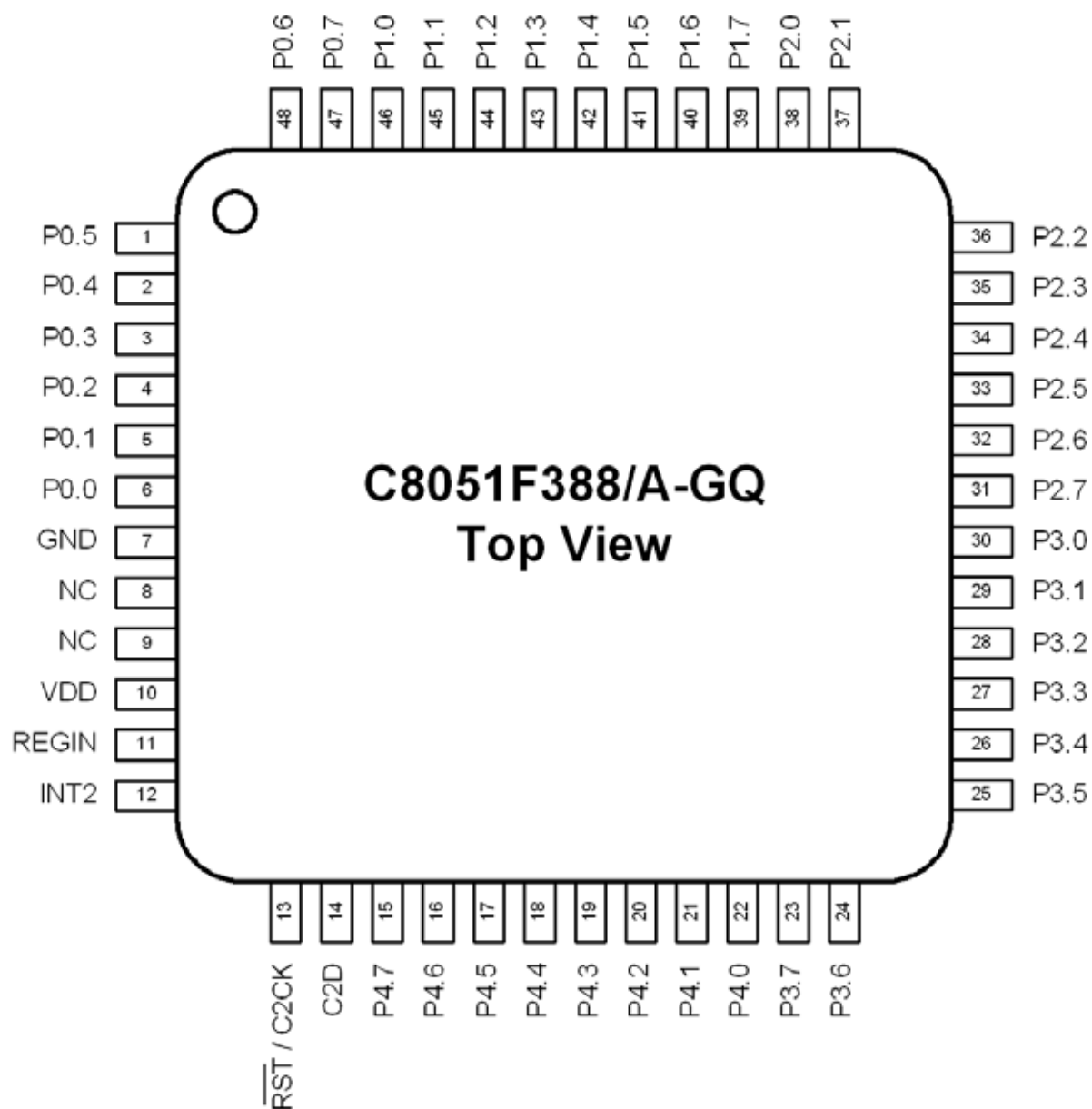


Figure 3.1. TQFP-48 (C8051F388/A) Pinout Diagram (Top View)

# C8051F388/9/A/B

**Table 5.7. Internal High-Frequency Oscillator Electrical Characteristics**

$V_{DD} = 2.7$  to  $3.6$  V;  $T_A = -40$  to  $+85$  °C unless otherwise specified; Using factory-calibrated settings.

Parameter	Test Condition	Min	Typ	Max	Unit
Oscillator Frequency	IFCN = 11b	47.3	48	48.7	MHz
Oscillator Supply Current (from $V_{DD}$ )	25 °C, $V_{DD} = 3.0$ V, OSCICN.7 = 1, OCSICN.5 = 0	—	900	—	μA
Power Supply Sensitivity	Constant Temperature	—	110	—	ppm/V
Temperature Sensitivity	Constant Supply	—	25	—	ppm/°C

**Table 5.8. Internal Low-Frequency Oscillator Electrical Characteristics**

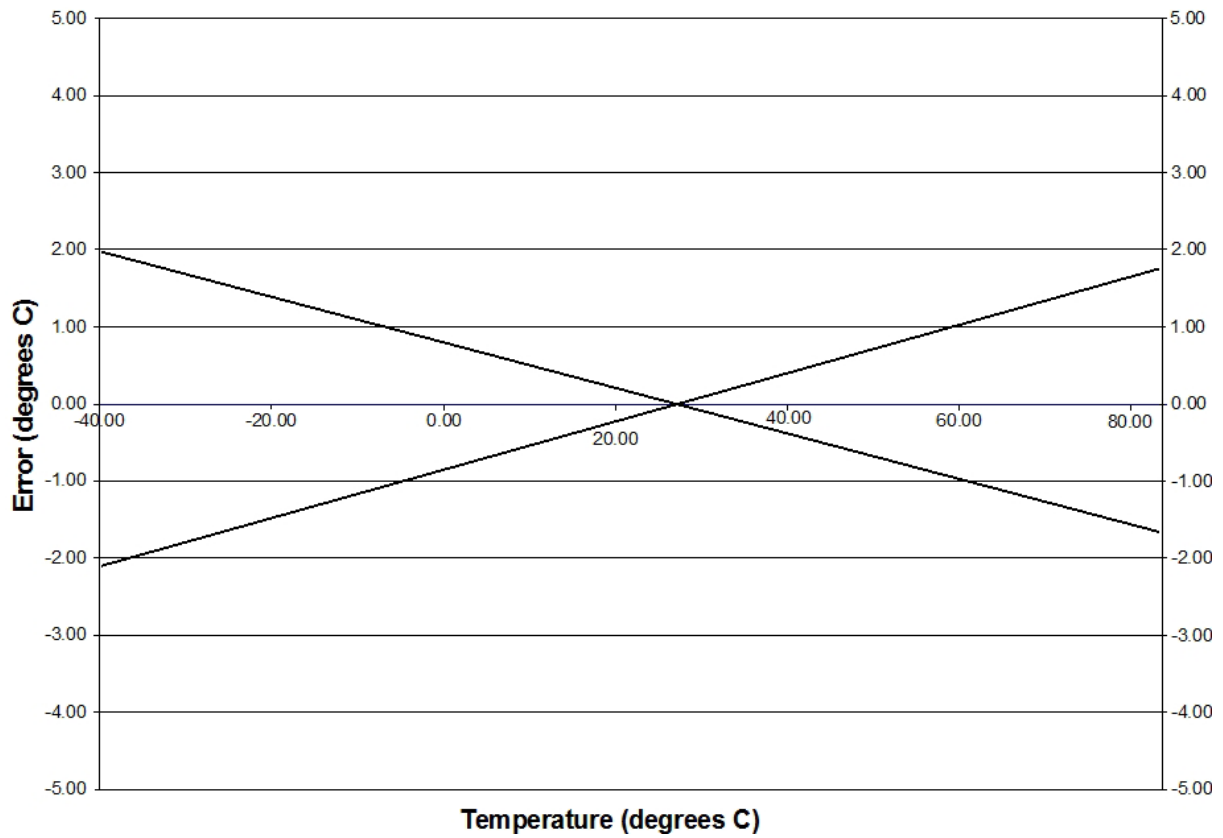
$V_{DD} = 2.7$  to  $3.6$  V;  $T_A = -40$  to  $+85$  °C unless otherwise specified; Using factory-calibrated settings.

Parameter	Test Condition	Min	Typ	Max	Unit
Oscillator Frequency	OSCLD = 11b	75	80	85	kHz
Oscillator Supply Current (from $V_{DD}$ )	25 °C, $V_{DD} = 3.0$ V, OSCLCN.7 = 1	—	4	—	μA
Power Supply Sensitivity	Constant Temperature	—	0.05	—	%/V
Temperature Sensitivity	Constant Supply	—	65	—	ppm/°C

**Table 5.9. External Oscillator Electrical Characteristics**

$V_{DD} = 2.7$  to  $3.6$  V;  $T_A = -40$  to  $+85$  °C unless otherwise specified.

Parameter	Test Condition	Min	Typ	Max	Unit
External Crystal Frequency		0.02	—	30	MHz
External CMOS Oscillator Frequency		0	—	48	MHz



**Figure 6.3. Temperature Sensor Error with 1-Point Calibration**

## 11.2. CIP-51 Register Descriptions

Following are descriptions of SFRs related to the operation of the CIP-51 System Controller. Reserved bits should always be written to the value indicated in the SFR description. Future product versions may use these bits to implement new features in which case the reset value of the bit will be the indicated value, selecting the feature's default state. Detailed descriptions of the remaining SFRs are included in the sections of the datasheet associated with their corresponding system function.

### SFR Definition 11.1. DPL: Data Pointer Low Byte

Bit	7	6	5	4	3	2	1	0
Name	DPL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x82; SFR Page = All Pages

Bit	Name	Function
7:0	DPL[7:0]	<b>Data Pointer Low.</b> The DPL register is the low byte of the 16-bit DPTR.

### SFR Definition 11.2. DPH: Data Pointer High Byte

Bit	7	6	5	4	3	2	1	0
Name	DPH[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x83; SFR Page = All Pages

Bit	Name	Function
7:0	DPH[7:0]	<b>Data Pointer High.</b> The DPH register is the high byte of the 16-bit DPTR.

**SFR Definition 11.6. PSW: Program Status Word**

Bit	7	6	5	4	3	2	1	0
Name	CY	AC	F0	RS[1:0]		OV	F1	PARITY
Type	R/W	R/W	R/W	R/W		R/W	R/W	R
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7	CY	<b>Carry Flag.</b> This bit is set when the last arithmetic operation resulted in a carry (addition) or a borrow (subtraction). It is cleared to logic 0 by all other arithmetic operations.
6	AC	<b>Auxiliary Carry Flag.</b> This bit is set when the last arithmetic operation resulted in a carry into (addition) or a borrow from (subtraction) the high order nibble. It is cleared to logic 0 by all other arithmetic operations.
5	F0	<b>User Flag 0.</b> This is a bit-addressable, general purpose flag for use under software control.
4:3	RS[1:0]	<b>Register Bank Select.</b> These bits select which register bank is used during register accesses. 00: Bank 0, Addresses 0x00-0x07 01: Bank 1, Addresses 0x08-0x0F 10: Bank 2, Addresses 0x10-0x17 11: Bank 3, Addresses 0x18-0x1F
2	OV	<b>Overflow Flag.</b> This bit is set to 1 under the following circumstances: <ul style="list-style-type: none"> <li>• An ADD, ADDC, or SUBB instruction causes a sign-change overflow.</li> <li>• A MUL instruction results in an overflow (result is greater than 255).</li> <li>• A DIV instruction causes a divide-by-zero condition.</li> </ul> The OV bit is cleared to 0 by the ADD, ADDC, SUBB, MUL, and DIV instructions in all other cases.
1	F1	<b>User Flag 1.</b> This is a bit-addressable, general purpose flag for use under software control.
0	PARITY	<b>Parity Flag.</b> This bit is set to logic 1 if the sum of the eight bits in the accumulator is odd and cleared if the sum is even.

## 14.4. Multiplexed and Non-multiplexed Selection

The External Memory Interface is capable of acting in a Multiplexed mode or a Non-multiplexed mode, depending on the state of the EMD2 (EMIOCF.4) bit.

### 14.4.1. Multiplexed Configuration

In Multiplexed mode, the Data Bus and the lower 8-bits of the Address Bus share the same Port pins: AD[7:0]. In this mode, an external latch (74HC373 or equivalent logic gate) is used to hold the lower 8-bits of the RAM address. The external latch is controlled by the ALE (Address Latch Enable) signal, which is driven by the External Memory Interface logic. An example of a Multiplexed Configuration is shown in Figure 14.1.

In Multiplexed mode, the external MOVX operation can be broken into two phases delineated by the state of the ALE signal. During the first phase, ALE is high and the lower 8-bits of the Address Bus are presented to AD[7:0]. During this phase, the address latch is configured such that the 'Q' outputs reflect the states of the 'D' inputs. When ALE falls, signaling the beginning of the second phase, the address latch outputs remain fixed and are no longer dependent on the latch inputs. Later in the second phase, the Data Bus controls the state of the AD[7:0] port at the time  $\overline{RD}$  or  $\overline{WE}$  is asserted.

See Section "14.6.2. Multiplexed Mode" on page 101 for more information.

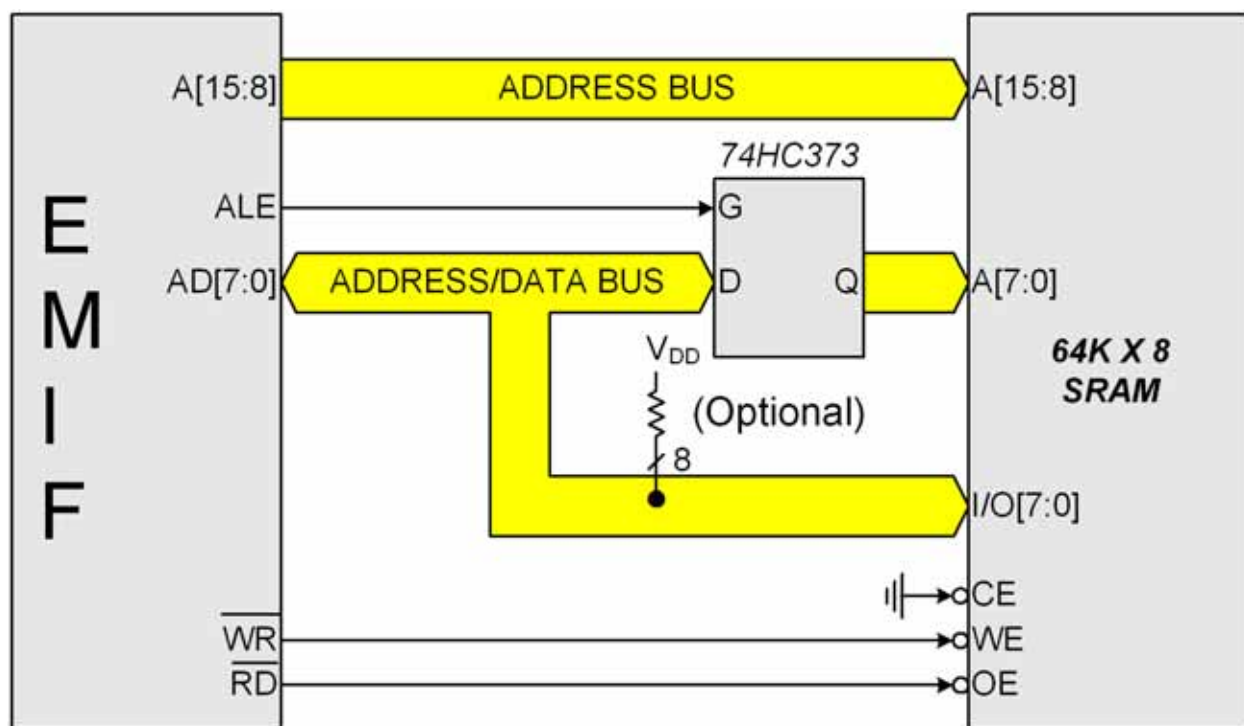


Figure 14.1. Multiplexed Configuration Example



**Table 14.1. AC Parameters for External Memory Interface**

Parameter	Description	Min*	Max*	Units
$T_{ACS}$	Address/Control Setup Time	0	$3 \times T_{SYSCLK}$	ns
$T_{ACW}$	Address/Control Pulse Width	$1 \times T_{SYSCLK}$	$16 \times T_{SYSCLK}$	ns
$T_{ACH}$	Address/Control Hold Time	0	$3 \times T_{SYSCLK}$	ns
$T_{ALEH}$	Address Latch Enable High Time	$1 \times T_{SYSCLK}$	$4 \times T_{SYSCLK}$	ns
$T_{ALEL}$	Address Latch Enable Low Time	$1 \times T_{SYSCLK}$	$4 \times T_{SYSCLK}$	ns
$T_{WDS}$	Write Data Setup Time	$1 \times T_{SYSCLK}$	$19 \times T_{SYSCLK}$	ns
$T_{WDH}$	Write Data Hold Time	0	$3 \times T_{SYSCLK}$	ns
$T_{RDS}$	Read Data Setup Time	20		ns
$T_{RDH}$	Read Data Hold Time	0		ns

**Note:**  $T_{SYSCLK}$  is equal to one period of the device system clock (SYSCLK).

# C8051F388/9/A/B

**Table 15.2. Special Function Registers (Continued)**

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Page	Description	Page
<b>SMB1CN</b>	0xC0	F	SMBus1 Control	177
<b>SMB1DAT</b>	0xC2	F	SMBus1 Data	183
<b>SMBTC</b>	0xB9	F	SMBus0/1 Timing Control	174
<b>SMOD1</b>	0xE5	All Pages	UART1 Mode	207
<b>SP</b>	0x81	All Pages	Stack Pointer	82
<b>SPI0CFG</b>	0xA1	All Pages	SPI Configuration	218
<b>SPI0CKR</b>	0xA2	All Pages	SPI Clock Rate Control	220
<b>SPI0CN</b>	0xF8	All Pages	SPI Control	219
<b>SPI0DAT</b>	0xA3	All Pages	SPI Data	220
<b>TCON</b>	0x88	All Pages	Timer/Counter Control	231
<b>TH0</b>	0x8C	All Pages	Timer/Counter 0 High	234
<b>TH1</b>	0x8D	All Pages	Timer/Counter 1 High	234
<b>TL0</b>	0x8A	All Pages	Timer/Counter 0 Low	233
<b>TL1</b>	0x8B	All Pages	Timer/Counter 1 Low	233
<b>TMOD</b>	0x89	All Pages	Timer/Counter Mode	232
<b>TMR2CN</b>	0xC8	0	Timer/Counter 2 Control	239
<b>TMR2H</b>	0xCD	0	Timer/Counter 2 High	241
<b>TMR2L</b>	0xCC	0	Timer/Counter 2 Low	240
<b>TMR2RLH</b>	0xCB	0	Timer/Counter 2 Reload High	240
<b>TMR2RLL</b>	0xCA	0	Timer/Counter 2 Reload Low	240
<b>TMR3CN</b>	0x91	0	Timer/Counter 3 Control	246
<b>TMR3H</b>	0x95	0	Timer/Counter 3 High	248
<b>TMR3L</b>	0x94	0	Timer/Counter 3 Low	247
<b>TMR3RLH</b>	0x93	0	Timer/Counter 3 Reload High	247
<b>TMR3RLL</b>	0x92	0	Timer/Counter 3 Reload Low	247
<b>TMR4CN</b>	0x91	F	Timer/Counter 4 Control	251
<b>TMR4H</b>	0x95	F	Timer/Counter 4 High	253
<b>TMR4L</b>	0x94	F	Timer/Counter 4 Low	252
<b>TMR4RLH</b>	0x93	F	Timer/Counter 4 Reload High	252
<b>TMR4RLL</b>	0x92	F	Timer/Counter 4 Reload Low	252
<b>TMR5CN</b>	0xC8	F	Timer/Counter 5 Control	256
<b>TMR5H</b>	0xCD	F	Timer/Counter 5 High	258
<b>TMR5L</b>	0xCC	F	Timer/Counter 5 Low	257
<b>TMR5RLH</b>	0xCB	F	Timer/Counter 5 Reload High	257

## 17.2. Power-Fail Reset / $V_{DD}$ Monitor

When a powerdown transition or power irregularity causes  $V_{DD}$  to drop below  $V_{RST}$ , the power supply monitor will drive the  $\overline{RST}$  pin low and hold the CIP-51 in a reset state (see Figure 17.2). When  $V_{DD}$  returns to a level above  $V_{RST}$ , the CIP-51 will be released from the reset state. Note that even though internal data memory contents are not altered by the power-fail reset, it is impossible to determine if  $V_{DD}$  dropped below the level required for data retention. If the PORSF flag reads 1, the data may no longer be valid. The  $V_{DD}$  monitor is enabled after power-on resets. Its defined state (enabled/disabled) is not altered by any other reset source. For example, if the  $V_{DD}$  monitor is disabled by code and a software reset is performed, the  $V_{DD}$  monitor will still be disabled after the reset.

**Important Note:** If the  $V_{DD}$  monitor is being turned on from a disabled state, it should be enabled before it is selected as a reset source. Selecting the  $V_{DD}$  monitor as a reset source before it is enabled and stabilized may cause a system reset. In some applications, this reset may be undesirable. If this is not desirable in the application, a delay should be introduced between enabling the monitor and selecting it as a reset source. The procedure for enabling the  $V_{DD}$  monitor and configuring it as a reset source from a disabled state is shown below:

1. Enable the  $V_{DD}$  monitor (VDMEN bit in VDM0CN = 1).
2. If necessary, wait for the  $V_{DD}$  monitor to stabilize (see Table 5.4 for the  $V_{DD}$  Monitor turn-on time).
3. Select the  $V_{DD}$  monitor as a reset source (PORSF bit in RSTSRC = 1).

See Figure 17.2 for  $V_{DD}$  monitor timing; note that the power-on-reset delay is not incurred after a  $V_{DD}$  monitor reset. See Table 5.4 for complete electrical characteristics of the  $V_{DD}$  monitor.

## SFR Definition 19.3. OSCICN: Internal H-F Oscillator Control

Bit	7	6	5	4	3	2	1	0
Name	IOSCEN	IFRDY	SUSPEND				IFCN[1:0]	
Type	R/W	R	R/W	R	R	R	R/W	
Reset	1	1	0	0	0	0	0	0

SFR Address = 0xB2; SFR Page = All Pages

Bit	Name	Function
7	IOSCEN	<b>Internal H-F Oscillator Enable Bit.</b> 0: Internal H-F Oscillator Disabled. 1: Internal H-F Oscillator Enabled.
6	IFRDY	<b>Internal H-F Oscillator Frequency Ready Flag.</b> 0: Internal H-F Oscillator is not running at programmed frequency. 1: Internal H-F Oscillator is running at programmed frequency.
5	SUSPEND	<b>Internal Oscillator Suspend Enable Bit.</b> Setting this bit to logic 1 places the internal oscillator in SUSPEND mode. The internal oscillator resumes operation when one of the SUSPEND mode awakening events occurs.
4:2	Unused	Read = 000b; Write = don't care
1:0	IFCN[1:0]	<b>Internal H-F Oscillator Frequency Divider Control Bits.</b> The Internal H-F Oscillator is divided by the IFCN bit setting after a divide-by-4 stage. 00: SYSCLK can be derived from Internal H-F Oscillator divided by 8 (1.5 MHz). 01: SYSCLK can be derived from Internal H-F Oscillator divided by 4 (3 MHz). 10: SYSCLK can be derived from Internal H-F Oscillator divided by 2 (6 MHz). 11: SYSCLK can be derived from Internal H-F Oscillator divided by 1 (12 MHz).

### 19.3. Clock Multiplier

The C8051F388/9/A/B device includes a 48 MHz high-frequency oscillator instead of a 12 MHz oscillator and a 4x Clock Multiplier. For compatibility with C8051F34x and C8051F32x devices however, the CLK-MUL register (SFR Definition 19.4) behaves as if the Clock Multiplier is present and working.

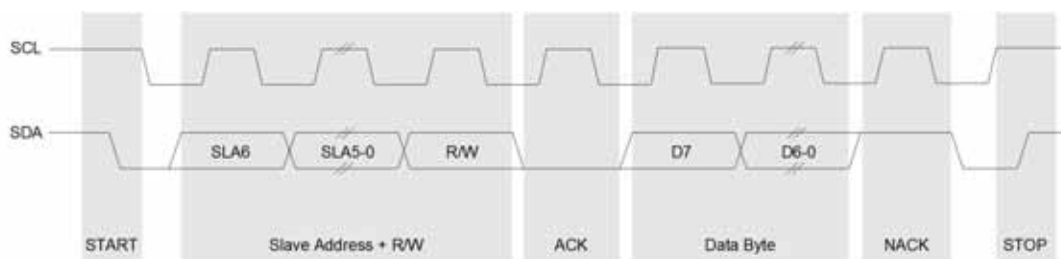
#### SFR Definition 19.4. CLKMUL: Clock Multiplier Control

Bit	7	6	5	4	3	2	1	0
Name	MULEN	MULINIT	MULRDY				MULSEL[1:0]	
Type	R	R	R	R	R	R	R	
Reset	1	1	1	0	0	0	0	0

SFR Address = 0xB9; SFR Page = 0

Bit	Name	Description
7	MULEN	<b>Clock Multiplier Enable Bit.</b> This bit always reads 1.
6	MULINIT	<b>Clock Multiplier Initialize Bit.</b> This bit always reads 1.
5	MULRDY	<b>Clock Multiplier Ready Bit.</b> This bit always reads 1.
4:2	Unused	Read = 000b; Write = don't care
1:0	MULSEL[1:0]	<b>Clock Multiplier Input Select Bits.</b> These bits always read 00.

All transactions are initiated by a master, with one or more addressed slave devices as the target. The master generates the START condition and then transmits the slave address and direction bit. If the transaction is a WRITE operation from the master to the slave, the master transmits the data a byte at a time waiting for an ACK from the slave at the end of each byte. For READ operations, the slave transmits the data waiting for an ACK from the master at the end of each byte. At the end of the data transfer, the master generates a STOP condition to terminate the transaction and free the bus. Figure 21.3 illustrates a typical SMBus transaction.



**Figure 21.3. SMBus Transaction**

### 21.3.1. Transmitter Vs. Receiver

On the SMBus communications interface, a device is the “transmitter” when it is sending an address or data byte to another device on the bus. A device is a “receiver” when an address or data byte is being sent to it from another device on the bus. The transmitter controls the SDA line during the address or data byte. After each byte of address or data information is sent by the transmitter, the receiver sends an ACK or NACK bit during the ACK phase of the transfer, during which time the receiver controls the SDA line.

### 21.3.2. Arbitration

A master may start a transfer only if the bus is free. The bus is free after a STOP condition or after the SCL and SDA lines remain high for a specified time (see Section “21.3.5. SCL High (SMBus Free) Timeout” on page 169). In the event that two or more devices attempt to begin a transfer at the same time, an arbitration scheme is employed to force one master to give up the bus. The master devices continue transmitting until one attempts a HIGH while the other transmits a LOW. Since the bus is open-drain, the bus will be pulled LOW. The master attempting the HIGH will detect a LOW SDA and lose the arbitration. The winning master continues its transmission without interruption; the losing master becomes a slave and receives the rest of the transfer if addressed. This arbitration scheme is non-destructive: one device always wins, and no data is lost.

### 21.3.3. Clock Low Extension

SMBus provides a clock synchronization mechanism, similar to I2C, which allows devices with different speed capabilities to coexist on the bus. A clock-low extension is used during a transfer in order to allow slower slave devices to communicate with faster masters. The slave may temporarily hold the SCL line LOW to extend the clock low period, effectively decreasing the serial clock frequency.

### 21.3.4. SCL Low Timeout

If the SCL line is held low by a slave device on the bus, no further communication is possible. Furthermore, the master cannot force the SCL line high to correct the error condition. To solve this problem, the SMBus protocol specifies that devices participating in a transfer must detect any clock cycle held low longer than 25 ms as a “timeout” condition. Devices that have detected the timeout condition must reset the communication no later than 10 ms after detecting the timeout condition.

For the SMBus0 interface, Timer 3 is used to implement SCL low timeouts. Timer 4 is used on the SMBus1 interface for SCL low timeouts. The SCL low timeout feature is enabled by setting the SMBnTOE bit in SMBnCF. The associated timer is forced to reload when SCL is high, and allowed to count when SCL is



1. Clear RI1 to 0
2. Read SBUF1
3. Check RI1, and repeat at Step 1 if RI1 is set to 1.

If the extra bit function is enabled ( $XBE1 = 1$ ) and the parity function is disabled ( $PE1 = 0$ ), the extra bit for the oldest byte in the FIFO can be read from the RBX1 bit (SCON1.2). If the extra bit function is not enabled, the value of the stop bit for the oldest FIFO byte will be presented in RBX1. When the parity function is enabled ( $PE1 = 1$ ), hardware will check the received parity bit against the selected parity type (selected with S1PT[1:0]) when receiving data. If a byte with parity error is received, the PERR1 flag will be set to 1. This flag must be cleared by software. Note: when parity is enabled, the extra bit function is not available.

### 23.3.3. Multiprocessor Communications

UART1 supports multiprocessor communication between a master processor and one or more slave processors by special use of the extra data bit. When a master processor wants to transmit to one or more slaves, it first sends an address byte to select the target(s). An address byte differs from a data byte in that its extra bit is logic 1; in a data byte, the extra bit is always set to logic 0.

Setting the MCE1 bit (SMOD1.7) of a slave processor configures its UART such that when a stop bit is received, the UART will generate an interrupt only if the extra bit is logic 1 ( $RBX1 = 1$ ) signifying an address byte has been received. In the UART interrupt handler, software will compare the received address with the slave's own assigned address. If the addresses match, the slave will clear its MCE1 bit to enable interrupts on the reception of the following data byte(s). Slaves that weren't addressed leave their MCE1 bits set and do not generate interrupts on the reception of the following data bytes, thereby ignoring the data. Once the entire message is received, the addressed slave resets its MCE1 bit to ignore all transmissions until it receives the next address byte.

Multiple addresses can be assigned to a single slave and/or a single address can be assigned to multiple slaves, thereby enabling "broadcast" transmissions to more than one slave simultaneously. The master processor can be configured to receive all transmissions or a protocol can be implemented such that the master/slave role is temporarily reversed to enable half-duplex transmission between the original master and slave(s).

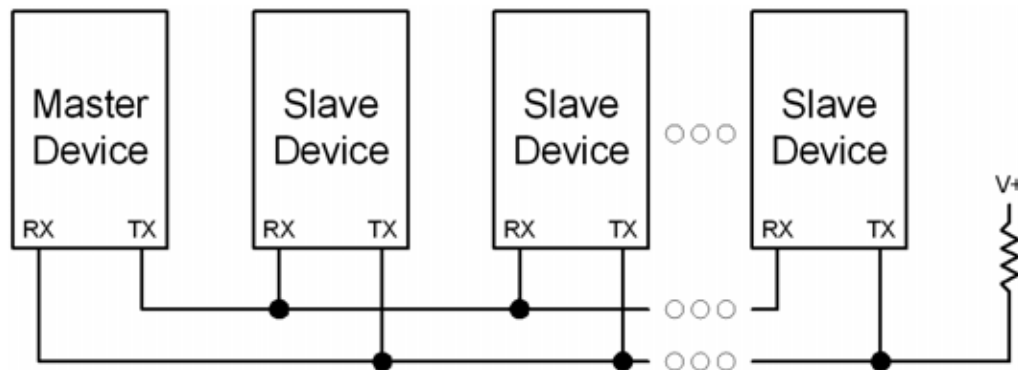


Figure 23.6. UART Multi-Processor Mode Interconnect Diagram





In Mode 3, Timer 0 is configured as two separate 8-bit counter/timers held in TL0 and TH0. The counter/timer in TL0 is controlled using the Timer 0 control/status bits in TCON and TMOD: TR0, C/T0, GATE0 and TF0. TL0 can use either the system clock or an external input signal as its timebase. The TH0 register is restricted to a timer function sourced by the system clock or prescaled clock. TH0 is enabled using the Timer 1 run control bit TR1. TH0 sets the Timer 1 overflow flag TF1 on overflow and thus controls the Timer 1 interrupt.

Timer 1 is inactive in Mode 3. When Timer 0 is operating in Mode 3, Timer 1 can be operated in Modes 0, 1 or 2, but cannot be clocked by external signals nor set the TF1 flag and generate an interrupt. However, the Timer 1 overflow can be used to generate baud rates or overflow conditions for other peripherals. While Timer 0 is operating in Mode 3, Timer 1 run control is handled through its mode settings. To run Timer 1 while Timer 0 is in Mode 3, set the Timer 1 Mode as 0, 1, or 2. To disable Timer 1, configure it for Mode 3.

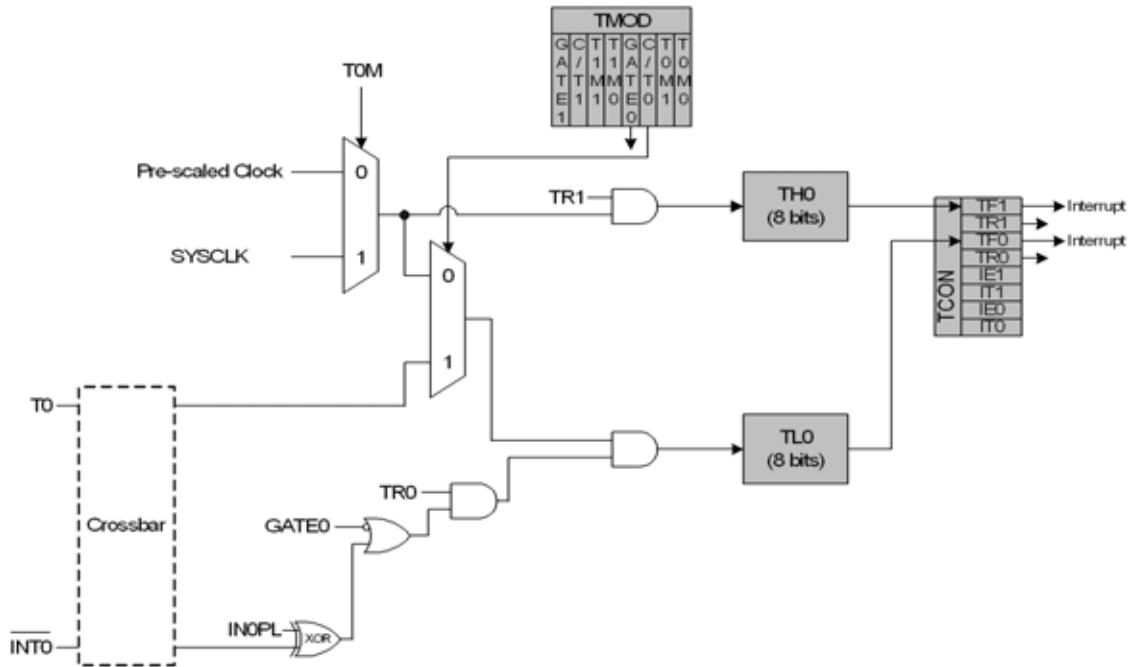


Figure 25.3. T0 Mode 3 Block Diagram



## 26.4. Watchdog Timer Mode

A programmable watchdog timer (WDT) function is available through the PCA Module 4. The WDT is used to generate a reset if the time between writes to the WDT update register (PCA0CPH4) exceed a specified limit. The WDT can be configured and enabled/disabled as needed by software.

With the WDTE bit set in the PCA0MD register, Module 4 operates as a watchdog timer (WDT). The Module 4 high byte is compared to the PCA counter high byte; the Module 4 low byte holds the offset to be used when WDT updates are performed. **The Watchdog Timer is enabled on reset. Writes to some PCA registers are restricted while the Watchdog Timer is enabled.** The WDT will generate a reset shortly after code begins execution. To avoid this reset, the WDT should be explicitly disabled (and optionally re-configured and re-enabled if it is used in the system).

### 26.4.1. Watchdog Timer Operation

While the WDT is enabled:

- PCA counter is forced on.
- Writes to PCA0L and PCA0H are not allowed.
- PCA clock source bits (CPS2–CPS0) are frozen.
- PCA Idle control bit (CIDL) is frozen.
- Module 4 is forced into software timer mode.
- Writes to the Module 4 mode register (PCA0CPM4) are disabled.

While the WDT is enabled, writes to the CR bit will not change the PCA counter state; the counter will run until the WDT is disabled. The PCA counter run control bit (CR) will read zero if the WDT is enabled but user software has not enabled the PCA counter. If a match occurs between PCA0CPH4 and PCA0H while the WDT is enabled, a reset will be generated. To prevent a WDT reset, the WDT may be updated with a write of any value to PCA0CPH4. Upon a PCA0CPH4 write, PCA0H plus the offset held in PCA0CPL4 is loaded into PCA0CPH4 (See Figure 26.10).

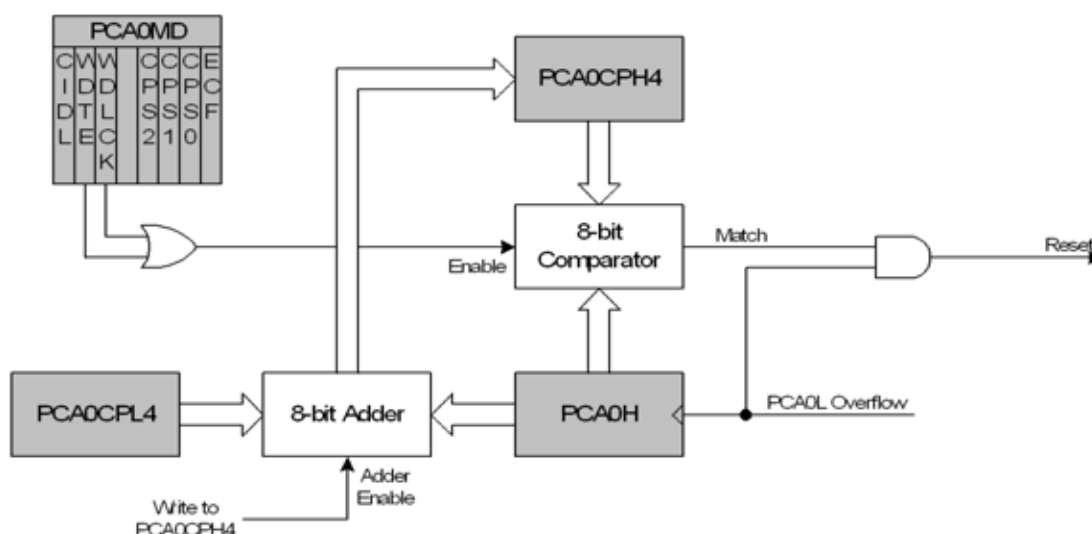


Figure 26.10. PCA Module 4 with Watchdog Timer Enabled

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## 28.2. INT2 Pin Not Connected

### Problem

The INT2 pin is non-functional on revision A C8051F388/9/A/B devices.

### Impacts

The INT2 pin cannot be used to generate an interrupt.

### Workaround

The /INT0 and /INT1 external interrupts are available on P0 and can still be used to generate an external pin interrupt.

### Resolution

This behavior has been corrected on revision B of this device.